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Renesas Electronics website: http://www.renesas.com

April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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## Silicon Epitaxial Trench Pin Diode for Antenna Switching

## RENESAS

ADE-208-948 (Z)

Rev. 0 Jul. 2000

#### Features

- Adopting the trench structure improves low capacitance. (C = 0.6 pF max)
- Low forward resistance. (rf =  $2.0 \Omega \max$ )
- Low operation current.
- Super small Flat Package (SFP) is suitable for surface mount design.

#### **Ordering Information**

Туре No	Laser Mark	Package Code
HVD135	5	SFP

#### Outline

1	
	1. Cathode 2. Anode

#### **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Value	Unit
Peak reverse voltage	V <sub>RM</sub>	65	V
Reverse voltage	V <sub>R</sub>	60	V
Forward current	I <sub>F</sub>	100	mA
Power dissipation	Pd	150	mW
Junction temperature	Tj	125	٥C
Storage temperature	Tstg	–55 to +125	°C

#### **Electrical Characteristics**

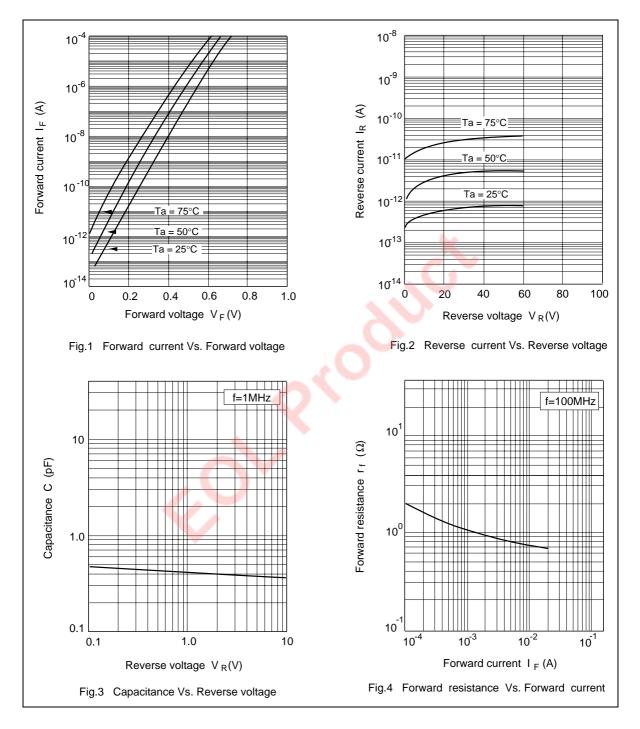
(Ta = 25°C)

ltem	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse current	I <sub>R</sub>	—		0.1	μΑ	$V_{R} = 60 V$
Forward voltage	V <sub>F</sub>	_	_	0.9	V	$I_F = 2 \text{ mA}$
Capacitance	С	_		0.6	pF	$V_{R} = 1 \text{ V}, \text{ f} = 1 \text{ MHz}$
Forward resistance	r <sub>f</sub>	_	_	2.0	Ω	I <sub>F</sub> = 2 mA, f = 100 MHz
ESD-Capability *1	_	100	- <	R	V	C = 200 pF, R = 0 $\Omega$ , Both forward and reverse direction 1 pulse.

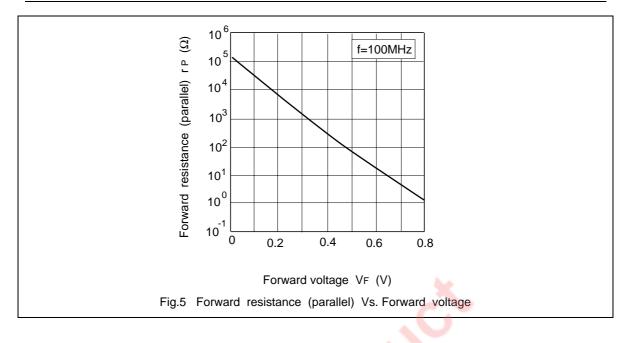
Notes : 1. Failure criterion ;  $I_R > 100$  nA at  $V_R = 60$  V

2. Please do not use the soldering iron due to avoid high stress to the SFP package.

#### **Main Characteristic**



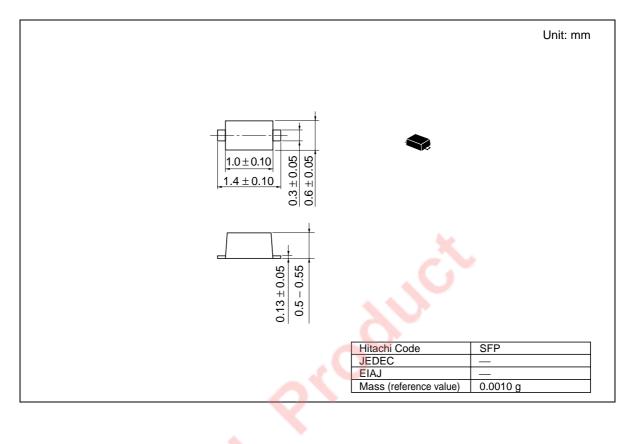
RENESAS



C. Rrodin



#### **Package Dimensions**



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